

74HCS00-Q100

Quad 2-input NAND gate with Schmitt-trigger inputs

Rev. 1 — 23 July 2025

Product data sheet

1. General description

The 74HCS00-Q100 is a quad 2-input NAND gate. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

All inputs are Schmitt-trigger inputs, capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Schmitt-trigger inputs
- Low power consumption
 - Typical supply current (I_{CC}) of 100 nA
 - Typical input leakage current (I_I) of ± 10 nA
- ± 7.8 mA output drive at 6 V
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
 - JESD7A (2.0 V to 6.0 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 3A exceeds 4000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1500 V
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automated Optical Inspection (AOI) of solder joints

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HCS00D-Q100	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74HCS00PW-Q100	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74HCS00BQ-Q100	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1

4. Functional diagram

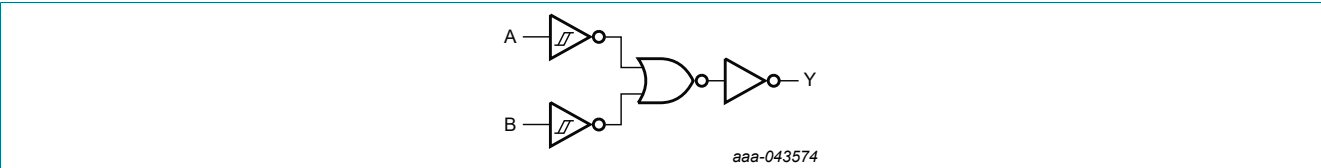


Fig. 1. Logic diagram (one gate)

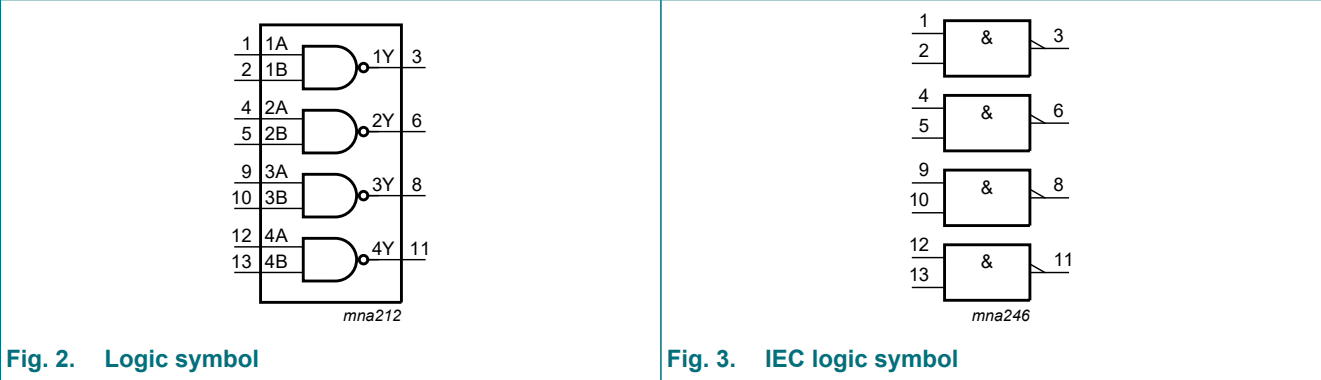
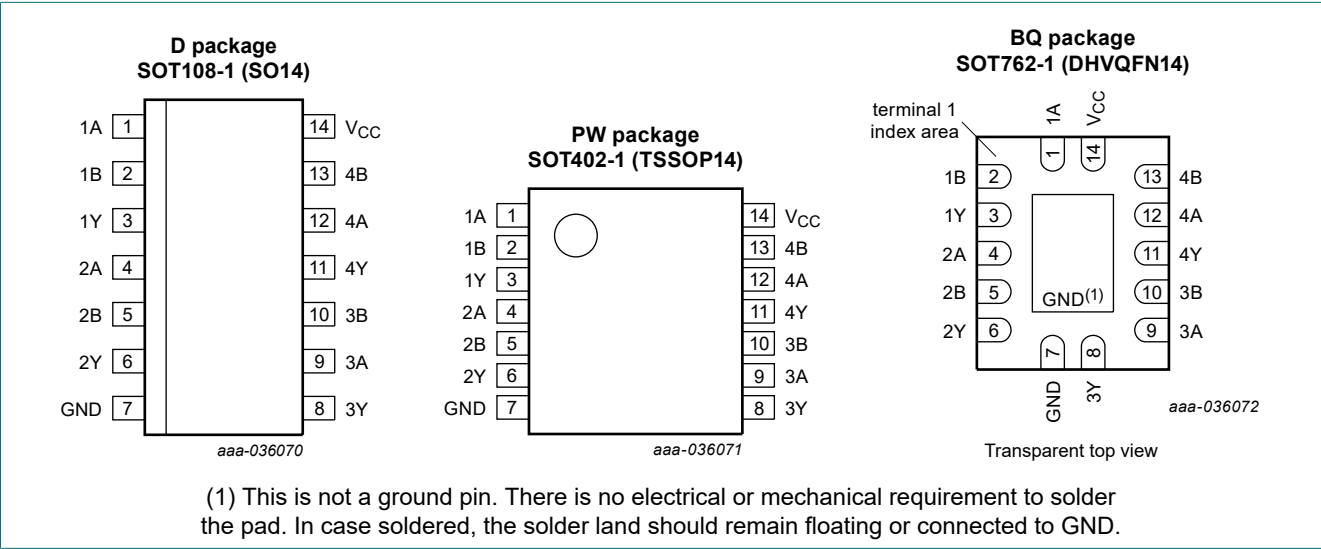


Fig. 2. Logic symbol

Fig. 3. IEC logic symbol

5. Pinning information

5.1. Pinning



(1) This is not a ground pin. There is no electrical or mechanical requirement to solder the pad. In case soldered, the solder land should remain floating or connected to GND.

5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1A, 2A, 3A, 4A	1, 4, 9, 12	data input
1B, 2B, 3B, 4B	2, 5, 10, 13	data input
1Y, 2Y, 3Y, 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V _{CC}	14	supply voltage

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care.

Input		Output
nA	nB	nY
L	X	H
X	L	H
H	H	L

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	V _I < -0.5 V or V _I > V _{CC} + 0.5 V [1]	-	±20	mA
I _{OK}	output clamping current	V _O < -0.5 V or V _O > V _{CC} + 0.5 V [1]	-	±20	mA
I _O	output current	V _O = 0 V to V _{CC}	-	±35	mA
I _{CC}	supply current		-	70	mA
I _{GND}	ground current		-70	-	mA
T _j	junction temperature	[2]	-	+150	°C
T _{stg}	storage temperature		-65	+150	°C
V _{ESD}	electrostatic discharge	HBM ANSI/ESDA/JEDEC JS-001 class 3A exceeds 4000 V	-	±4000	V
		CDM ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1500 V	-	±1500	V
P _{tot}	total power dissipation	[3]	-	500	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.
[2] Guaranteed by design.
[3] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C.
For SOT402-1 (TSSOP14) package: P_{tot} derates linearly with 7.3 mW/K above 81 °C.
For SOT762-1 (DHVQFN14) package: P_{tot} derates linearly with 9.6 mW/K above 98 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{CC}	supply voltage		2.0	5.0	6.0	V
V _I	input voltage		0	-	V _{CC}	V
V _O	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
V _{T+}	positive-going threshold voltage	see Fig. 4 and Fig. 5								
		V _{CC} = 2.0 V	0.7	-	1.5	0.7	1.5	0.7	1.5	V
		V _{CC} = 4.5 V	1.7	-	3.15	1.7	3.15	1.7	3.15	V
		V _{CC} = 6 V	2.1	-	4.2	2.1	4.2	2.1	4.2	V
		V _{CC} = 3.0 V to 3.6 V	0.4V _{CC}	-	0.7V _{CC}	0.4V _{CC}	0.7V _{CC}	0.4V _{CC}	0.7V _{CC}	V
		V _{CC} = 4.5 V to 5.5 V	0.38V _{CC}	-	0.7V _{CC}	0.38V _{CC}	0.7V _{CC}	0.38V _{CC}	0.7V _{CC}	V
V _{T-}	negative-going threshold voltage	see Fig. 4 and Fig. 5								
		V _{CC} = 2.0 V	0.3	-	1.0	0.3	1.0	0.3	1.0	V
		V _{CC} = 4.5 V	0.9	-	2.2	0.9	2.2	0.9	2.2	V
		V _{CC} = 6 V	1.2	-	3.0	1.2	3.0	1.2	3.0	V
		V _{CC} = 3.0 V to 3.6 V	0.2V _{CC}	-	0.5V _{CC}	0.2V _{CC}	0.5V _{CC}	0.2V _{CC}	0.5V _{CC}	V
		V _{CC} = 4.5 V to 5.5 V	0.2V _{CC}	-	0.49V _{CC}	0.2V _{CC}	0.49V _{CC}	0.2V _{CC}	0.49V _{CC}	V
V _H	hysteresis voltage[1]	see Fig. 4 and Fig. 5								
		V _{CC} = 2.0 V	0.2	0.52	1.0	0.2	1.0	0.2	1.0	V
		V _{CC} = 4.5 V	0.4	0.85	1.4	0.4	1.4	0.4	1.4	V
		V _{CC} = 6 V	0.6	1.1	1.6	0.6	1.6	0.6	1.6	V
		V _{CC} = 3.0 V to 3.6 V	0.1V _{CC}	0.72	0.38V _{CC}	0.1V _{CC}	0.38V _{CC}	0.1V _{CC}	0.38V _{CC}	V
		V _{CC} = 4.5 V to 5.5 V	0.09V _{CC}	0.94	0.29V _{CC}	0.09V _{CC}	0.29V _{CC}	0.09V _{CC}	0.29V _{CC}	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}								
		I _{OH} = -20 µA; V _{CC} = 2.0 V to 6 V	V _{CC} -0.1	V _{CC} -0.002	-	V _{CC} -0.1	-	V _{CC} -0.1	-	V
		I _{OH} = -4 mA; V _{CC} = 3.0 V	2.7	2.85	-	2.7	-	2.7	-	V
		I _{OH} = -6 mA; V _{CC} = 4.5 V	4.0	4.3	-	4.0	-	4.0	-	V
		I _{OH} = -7.8 mA; V _{CC} = 6.0 V	5.48	5.75	-	5.4	-	5.4	-	V

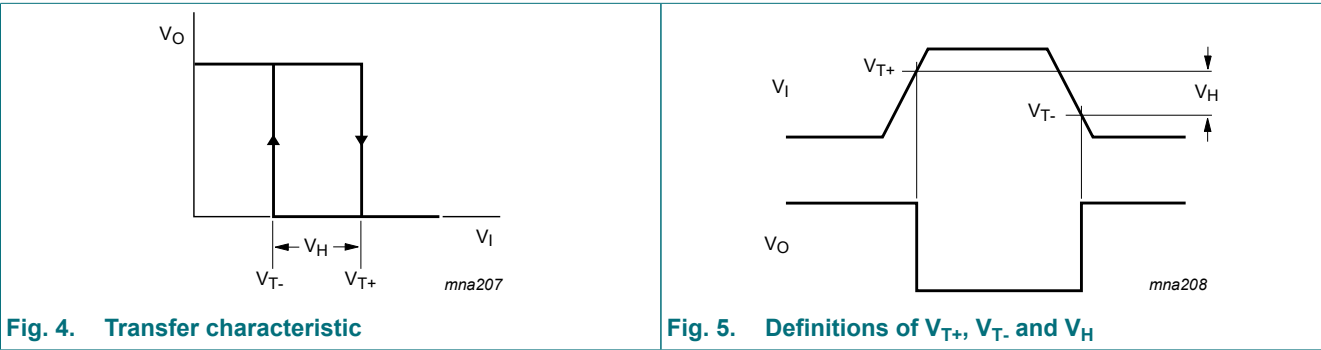
Quad 2-input NAND gate with Schmitt-trigger inputs

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}								
		I _{OL} = 20 µA; V _{CC} = 2.0 V to 6 V	-	0.002	0.1	-	0.1	-	0.1	V
		I _{OL} = 4 mA; V _{CC} = 3.0 V	-	0.14	0.25	-	0.25	-	0.25	V
		I _{OL} = 6 mA; V _{CC} = 4.5 V	-	0.18	0.26	-	0.30	-	0.30	V
		I _{OL} = 7.8 mA; V _{CC} = 6.0 V	-	0.22	0.26	-	0.33	-	0.33	V
I _I	input leakage current	V _I = V _{CC} or GND; V _{CC} = 6.0 V	-	±0.01	±0.1	-	±0.25	-	±1.0	µA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 6.0 V	-	0.1	-	-	0.5	-	2.0	µA

[1] Guaranteed by design.

9.1. Transfer characteristic waveforms and graphs

9.1.1. For inputs



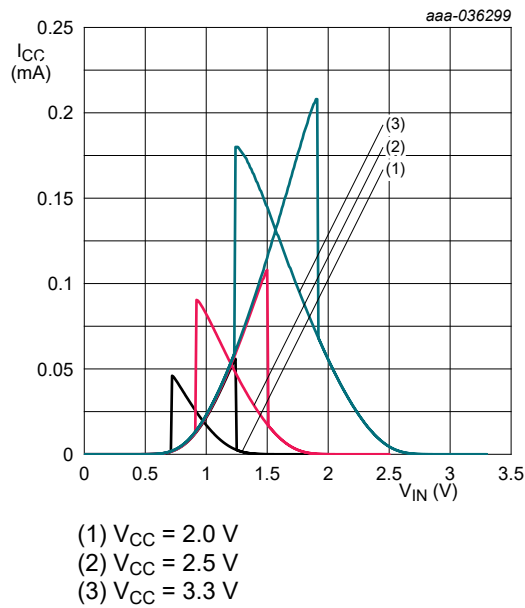


Fig. 6. Typical supply current vs the input voltage

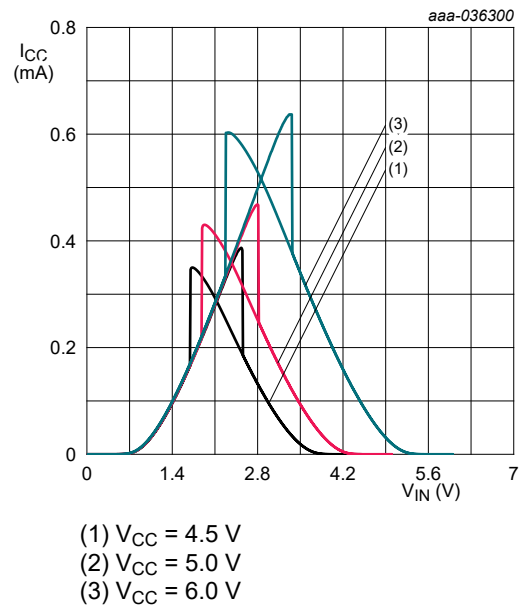


Fig. 7. Typical supply current vs the input voltage

9.1.2. For outputs

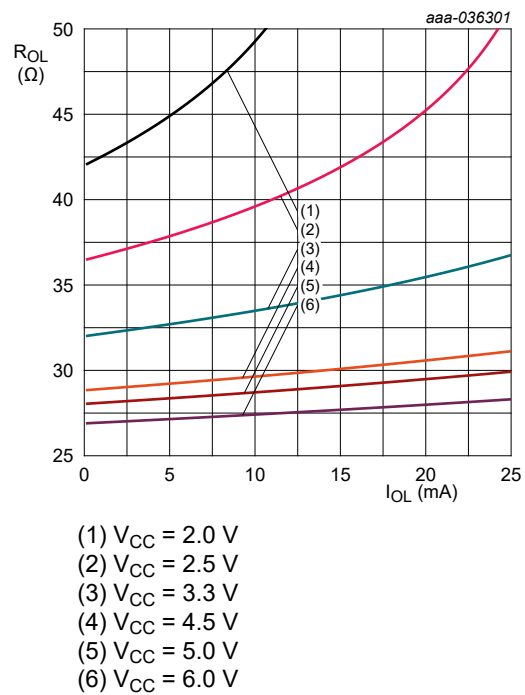


Fig. 8. Typical LOW-level output resistance as function of the output current

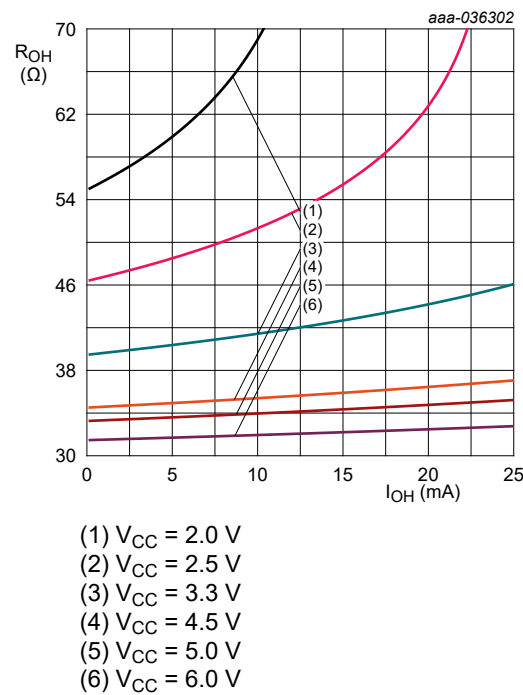


Fig. 9. Typical HIGH-level output resistance as function of the output current

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Section 10.1.

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
t _{pd}	propagation delay	nA, nB to nY; see Fig. 10 [2]								
		V _{CC} = 2 V	-	15	30	-	34	-	36	ns
		V _{CC} = 4.5 V	-	7	11	-	12	-	13	ns
		V _{CC} = 6 V	-	5	10	-	12	-	12	ns
		V _{CC} = 3.0 V to 3.6 V	-	7	15	-	17	-	18	ns
		V _{CC} = 4.5 V to 5.5 V	-	6	11	-	12	-	13	ns
t _t	transition time	nY; see Fig. 10 [3]								
		V _{CC} = 2 V	-	9	13	-	15	-	16	ns
		V _{CC} = 4.5 V	-	5	7	-	8	-	8	ns
		V _{CC} = 6 V	-	4	6	-	7	-	7	ns
		V _{CC} = 3.0 V to 3.6 V	-	5	8	-	9	-	10	ns
		V _{CC} = 4.5 V to 5.5 V	-	4	7	-	8	-	8	ns
C _I	input capacitance		-	1.5	-	-	5	-	5	pF
C _{PD}	power dissipation capacitance	f _i = 1 MHz; C _L = 0 pF; V _I = GND to V _{CC} ; V _{CC} = 2.0 V to 6.0 V [4]	-	7	-	-	-	-	-	pF

- [1] Typical values are measured at nominal supply voltage.
- [2] t_{pd} is the same as t_{PHL} and t_{PLH}.
- [3] t_t is the same as t_{THL} and t_{TLH}.
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
Σ(C_L × V_{CC}² × f_o) = sum of outputs;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V.

10.1. Waveforms and test circuit

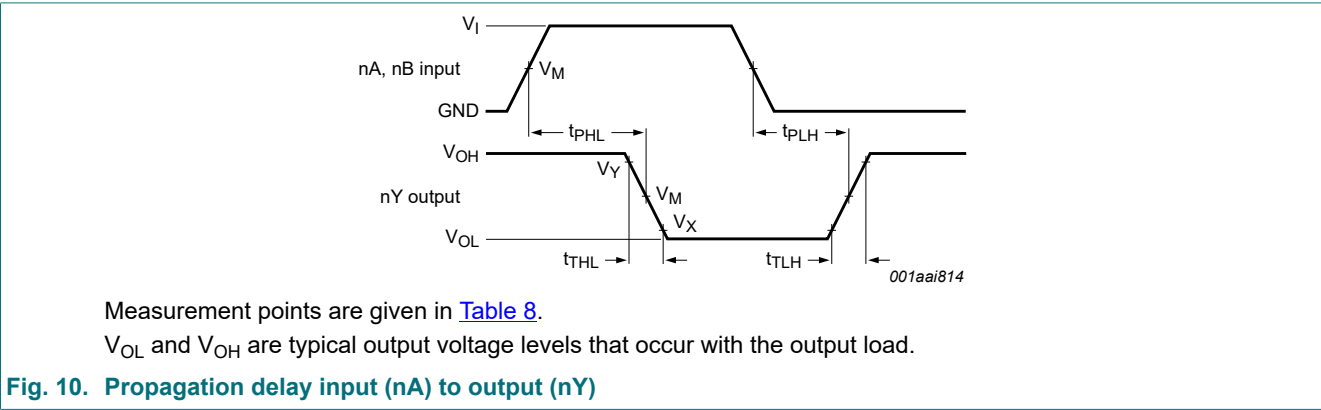


Table 8. Measurement points

Input	Output		
V_M	V_M	V_X	V_Y
$0.5V_{CC}$	$0.5V_{CC}$	10 %	90 %

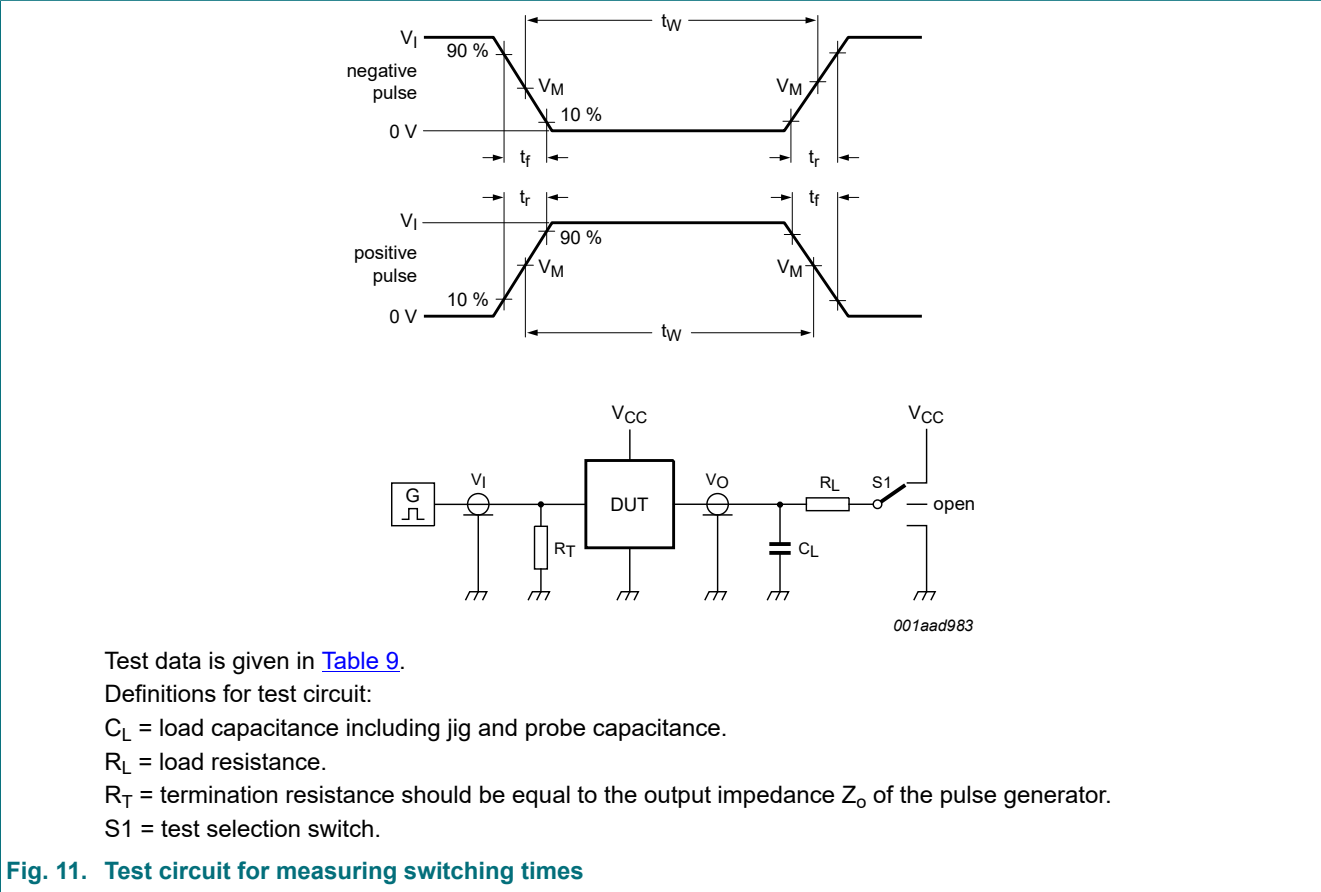


Table 9. Test data

Input		Load		S1 position		
V_I	t_r, t_f	C_L	R_L	t_{PHL}, t_{PLH}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
V_{CC}	2.5 ns	50 pF	1 kΩ	open	GND	V_{CC}

11. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

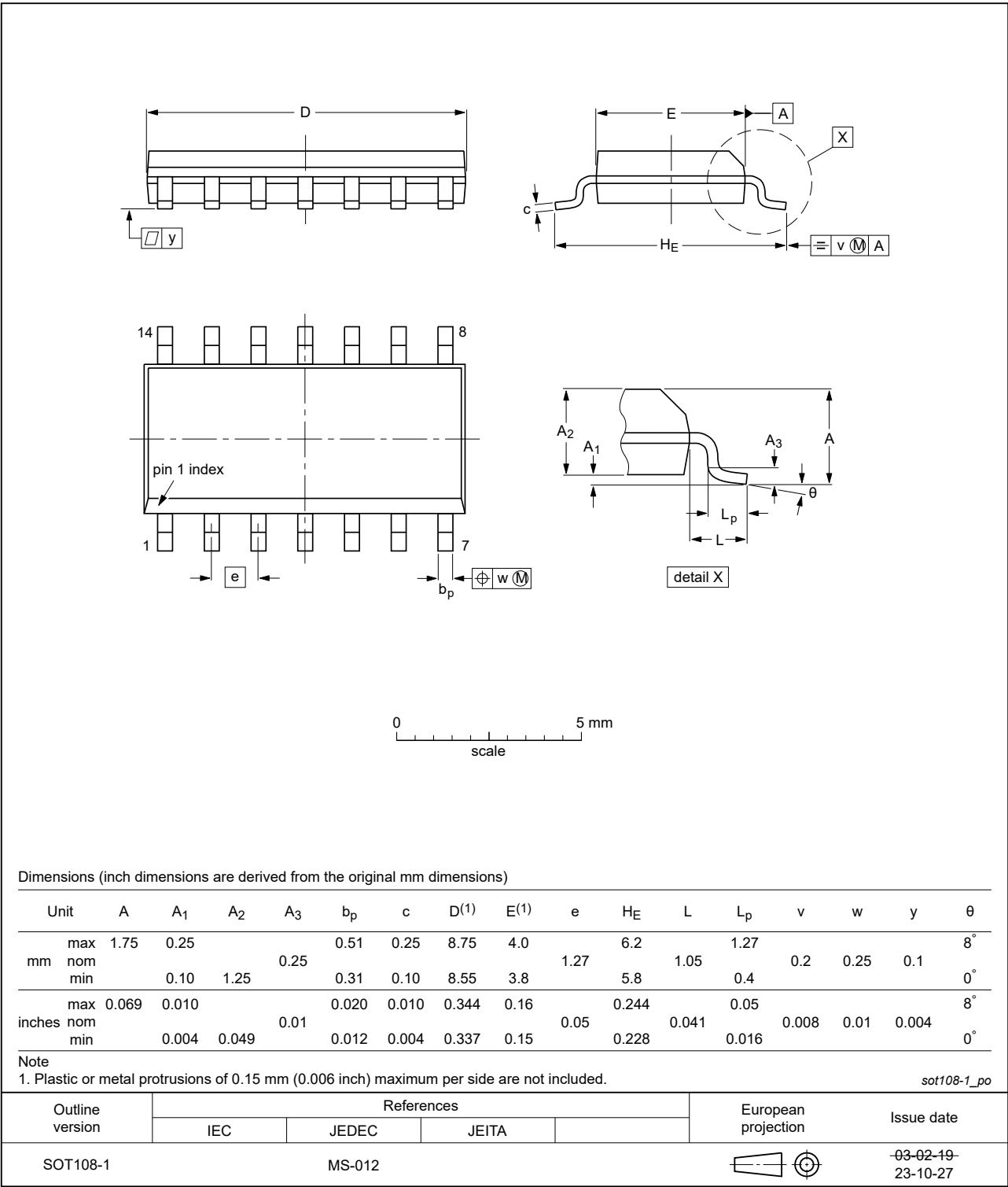


Fig. 12. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

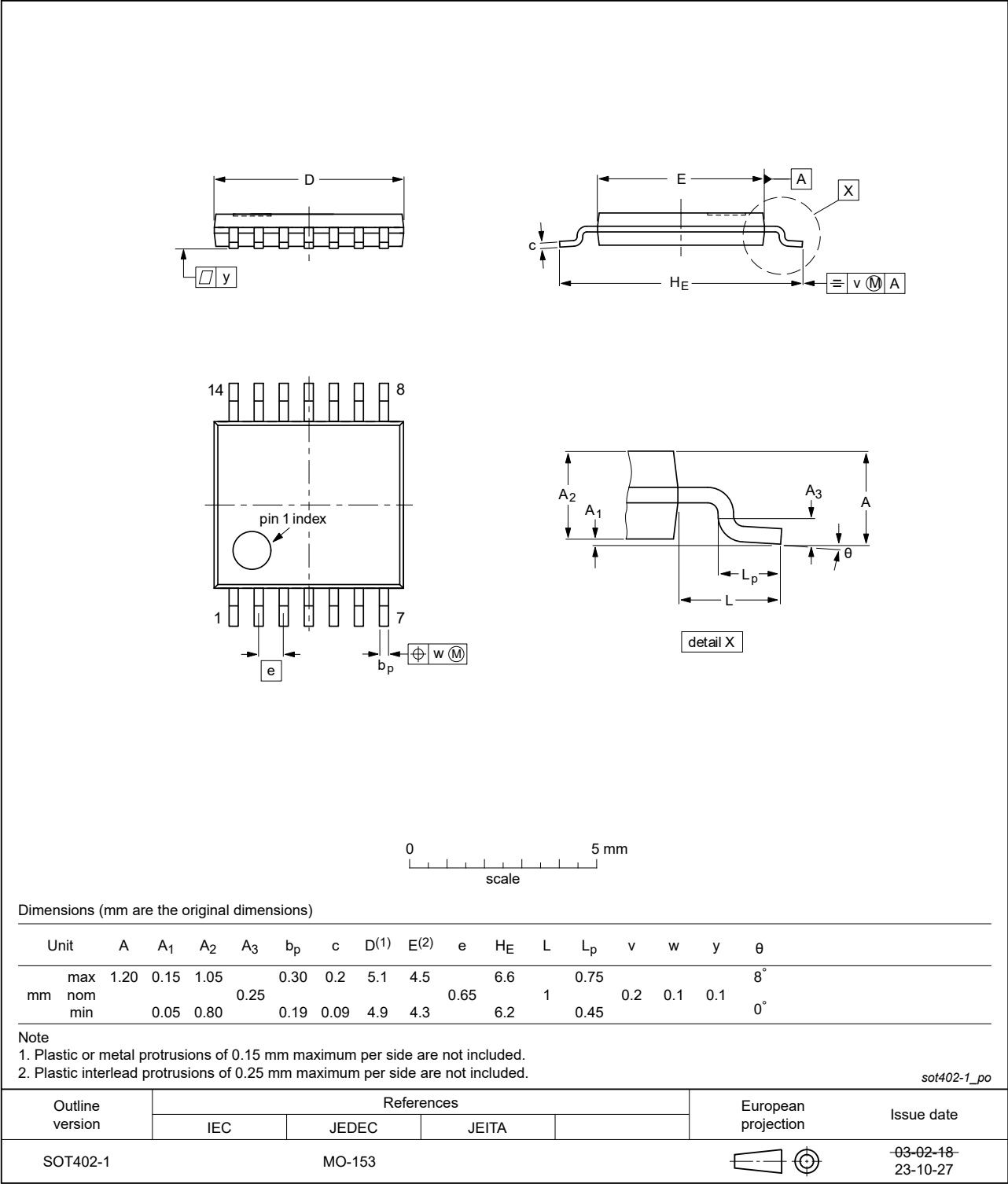


Fig. 13. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;
14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

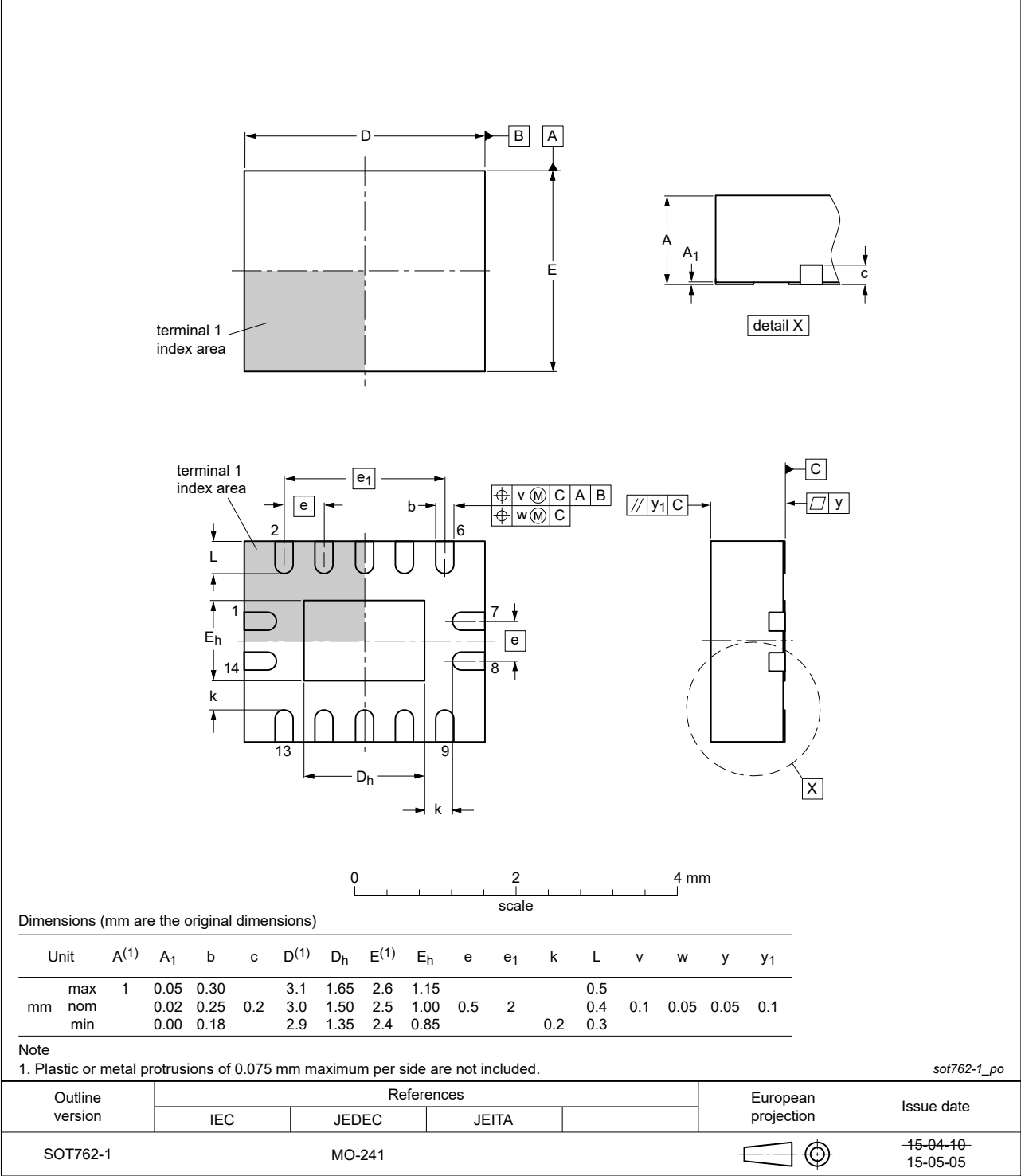


Fig. 14. Package outline SOT762-1 (DHVQFN14)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charge Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HCS00_Q100 v.1	20250723	Product data sheet	-	-

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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Date of release: 23 July 2025